

Educational and Recreational Camp "Politekhnik-4"

Peremohy Street 1, Zozuli village, Zolochiv district, Lviv region.

The conference will take place from September 27th to 30th, 2023, at the premises of the educational and recreational camp "Politekhnik-4" in the village of Zozuli, located 80 km from Lviv and 5 km from Zolochiv.

"Politekhnik-4" is situated in a picturesque corner of Lviv region, surrounded by pine forests. Beautiful nature, clean air, vast forest areas, and unique plant species contribute to a comfortable stay in cozy rooms. In the camp and its vicinity, various activities can be enjoyed, including hiking, while admiring the surrounding mountains.

"Politekhnik-4" offers double and triple rooms, as well as suites and luxury accommodations. Each building has facilities for cooking and dining.



Travel arrangement

There are several interesting places worth visiting.

Zolochiv Castle (5 km from the camp) is one of the most well-known tourist attractions in Zolochiv. The castle was founded in the 17th century and features fortification architecture. Visitors can explore its walls, towers, and interior spaces, which recreate a historical atmosphere.

Olesko Castle (30 km from the camp) is renowned for its unique architecture that combines elements of fortification with Renaissance and Baroque styles.

Pidhirtsi Castle (16 km away) is located near Zolochiv. It was constructed in the 16th century and represents a vast fortress with towers and defensive structures.

You can find more information:

<http://lvivgallery.org.ua/museums/muzey-zapovidnyk-zolochivskyy-zamok>

Paper submission

Length of papers are from 4 to 5 full pages.

The full paper should be prepared in WinWord format with page set up to A4 (210 x 297 mm) size paper.

Full paper should be submitted to the Organising Committee only in electronic form (MSWord, Rich Text Format).

The required format is available on the Conference Web Page. Authors are asked to indicate the topic into which their papers fall.

Papers will be printed in the proceedings directly from the files submitted by the authors.

All accepted papers and oral (or poster) presenting at MEMSTECH-2023 will be submitted for revision to IEEE Xplore Digital Library. "No-show" papers won't be submitted for inclusion in IEEE Xplore Digital Library.

Language

The working language is English.

Registration fee

Registration fee includes: admission to the conference sessions, coffee breaks, printed program and proceedings.

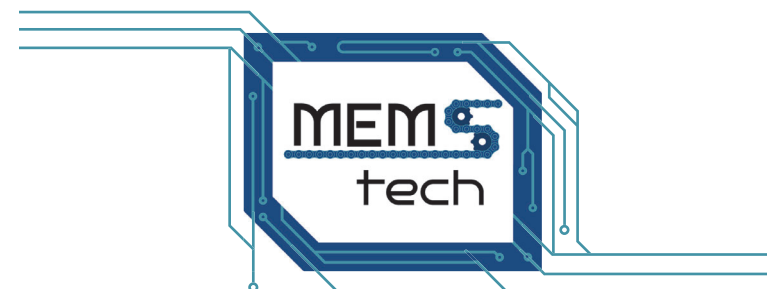
Registration fees	Price
Standard	150 Euro
Students and PhD students	80 Euro
IEEE Members	120 Euro

Important dates

August 1, 2023 Deadline for final Camera-Ready Papers submissions (in English).

September 9, 2023 Notification of Papers acceptance.

Call for PAPERS MEMSTECH 2023



XIXth International Conference

**PERSPECTIVE TECHNOLOGIES
AND METHODS IN MEMS DESIGN**

27 - 30 September 2023

Zozuli (Lviv region), Ukraine



IEEE
UKRAINE SECTION



IEEE

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Topics include, but not limited to

- Devices ranging in size from microns to millimeters,
- Micro actuators,
- Micro robots,
- Micro batteries,
- New materials and designs for MEMS,
- IC-compatible fabrication techniques,
- Other fabrication techniques,
- Measurement of micro phenomena,
- Theoretical results,
- Electrical interconnections,
- Micro telemanipulation, and standards appropriate to MEMS;
- Application examples and application oriented devices in fluidics, optics and bio-medical engineering.

Topics include, but not limited to

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<https://mfa.gov.ua/en/consular-affairs/entry-and-stay-foreigners-ukraine/entry-regime-ukraine-foreign-citizens>

http://en.wikipedia.org/wiki/Visa_policy_of_Ukraine

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